## <u>GEO to take part in Hong Kong Book</u> <u>Fair 2024 to promote slope safety</u>

The Geotechnical Engineering Office (GEO) of the Civil Engineering and Development Department will set up a booth at the Hong Kong Book Fair from tomorrow (July 17) to July 23 to introduce the Hong Kong Slope Safety System and promote the GEO's publications.

The GEO will showcase how to leverage innovative technologies to enhance the capability to handle landslides and respond to post-disaster risks. Visitors can experience a landslide scenario through virtual reality and take part in a virtual tour to the Hong Kong Geoparks. They can also read the Digital Learning and Teaching Aids for Secondary School Geography and related books published by the GEO.

Members of the public are invited to visit the booth located at Stall B26 in Hall 1B of the Hong Kong Convention and Exhibition Centre.